

Distribution of Proton-Induced Transients in Silicon Focal Plane Arrays

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Outline



- Motivation
- Experimental Setup
- Modeling Description
- Results
 - Direct ionization dominates event rates
 - Path length and constant dE/dx method does not capture full distribution
- Conclusions



Motivation

- Proton events contribute to device noise floor
- Better understanding of how radiation-induced energy deposition occurs will improve prediction techniques
- Accurate modeling helps predict on-orbit response







Experimental Setup

- Back side hybrid FPA consisting of a silicon p-i-n 128 × 128 detector array with hardened CMOS readout integrated circuit (ROIC)
- Full radiometric characterizations were performed
 - Dark current, noise, responsivity, and sensitivity
- Biased to 15 V resulting in full depletion
- Irradiated with 63 MeV protons at 45°
- Exposed at 233 K

Hybrid FPA Cross section





TCAD Simulations



 TCAD simulations revealed rectangular parallelepiped (RPP) assumption was sufficient to estimate device response to radiation







Monte Carlo Simulations

- MRED (Monte Carlo Radiative Energy Deposition), a Geant4 based tool, used for simulation
- Sensitive volume equal in size to one pixel



Pile Up



- Accounts for the probability of multiple hits on a single pixel
- Based on a measure of the mean number of hits per pixel during a single integration time



 σ = Integral cross section ϕ = Flux τ = Integration time



Non Radiation Noise

- Broadening at zero region shows amount of system noise present
- Gaussian convolution used to apply noise to simulation





Post Processing Results



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Results





- Good agreement
 below 300 keV
- Differences past 300 keV due to
 - Simplification of structure
 - Known error in nuclear reaction models, see R.A.
 Reed, et. al., TNS 2007
 - Charge sharing between pixels



Reaction Mechanisms

- Direct ionization is dominant mechanism below 450 keV
- Coulomb scattering does not contribute significantly here



Constant dE/dx and Path Length Distribution Calculation



Energy Deposited = $dE/dx \times Path$ Length



- Fluctuation of dE/dx is not considered
- Variation in distribution comes from path length only in this type of calculation

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- Proton environment from CREME96
- Geosynchronous orbit, worst week





Implications for Space



Conclusions



- Direct ionization dominates the cross section below 450 keV from incident 63 MeV protons
- Constant dE/dx and path length calculation does not address fluctuations in dE/dx and therefore does not capture the full distribution
- A high fidelity simulation is needed to accurately predict device response



Future Work with Si p-i-n FPA

- Include entire pixel array with underlying indium and ROIC.
- Normal incidence will reduce backscattering
- More ionizing lower energy protons (12 MeV)
- Charge moves along track, but does it move laterally between pixels?





Future Work with HgCdTe FPAs

63 MeV

Proton

Pixel 2

Pixel

Pixel 3

- Methods developed with Si p-i-n FPAs applied to HgCdTe FPAs
- Crosstalk is more problematic in HgCdTe detectors because they are used at cold temperatures. Charge sharing will be studied.

